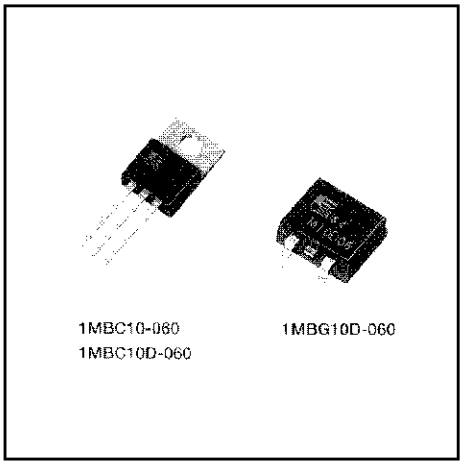
1MBC10-060,1MBC10D-060,
1MBG10D-060

Molded IGBT

600V / 10A
Molded Package



■ Features

· Small molded package
· Low power loss
· Soft switching with low switching surge and noise
· High reliability, high ruggedness (RBSOA, SCSOA etc.)
· Comprehensive line-up

■ Applications

· Inverter for Motor drive
· AC and DC Servo drive amplifier
· Uninterruptible power supply

■ Maximum ratings and characteristics

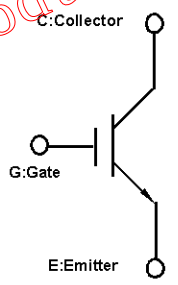
● **Absolute maximum ratings (at Tc=25°C unless otherwise specified)**

1MBC10-060 / IGBT

Item			Symbol	Rating	Unit
Collector-Emitter voltage			V_{CES}	600	V
Gate-Emitter voltaga			V_{GES}	±20	V
Collector current	DC	Tc=25°C	I_{C25}	20	A
		Tc=100°C	I_{C100}	10	A
	1ms	Tc=25°C	Icp	80	A
Max. power dissipation(IGBT)			P_C	75	W
Operating temperature			T_j	+150	°C
Storage temperature			T_{stg}	-40 to +150	°C
Screw torque			-	40	N·cm

■ Equivalent Circuit Schematic

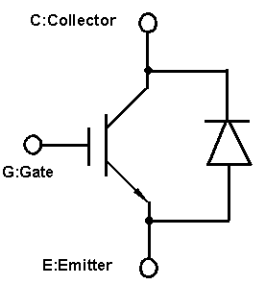
IGBT



1MBC10D-060, 1MBG10D-060 / IGBT+FWD

Item			Symbol	Rating	Unit
Collector-Emitter voltage			V_{CES}	600	V
Gate-Emitter voltaga			V_{GES}	±20	V
Collector current	DC	Tc=25°C	I_{C25}	20	A
		Tc=100°C	I_{C100}	10	A
	1ms	Tc=25°C	Icp	80	A
Max. power dissipation (IGBT)			P_C	75	W
Max. power dissipation (FWD)			P_C	35	W
Operating temperature			T_j	+150	°C
Storage temperature			T_{stg}	-40 to +150	°C
Screw torque			-	40	N·cm

IGBT + FWD



● Electrical characteristics (at Tj=25°C unless otherwise specified)

1MBC10-060 / IGBT

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I_{CES}	–	–	1.0	V_{GE}=0V, V_{CE}=600V	mA
Gate-Emitter leakage current	I_{GES}	–	–	20	V_{CE}=0V, V_{GE}=±20V	μA
Gate-Emitter threshold voltage	$V_{GE(th)}$	5.5	–	8.5	V_{CE}=20V, I_C=10mA	V
Collector-Emitter saturation voltage	$V_{CE(sat)}$	–	–	3.0	V_{GE}=15V, I_C=10A	V
Input capacitance	C_{ies}	–	700	–	V_{GE}=0V	pF
Output capacitance	C_{oes}	–	150	–	V_{CE}=10V	
Reverse transfer capacitance	C_{res}	–	20	–	f=1MHz	
Turn-on time	t_{on}	–	–	1.2	V_{CC}=300V I_C=10A	μs
	t_r	–	–	0.6	V_{GE}=±15V	
Turn-off time	t_{off}	–	–	1.0	R_G=220 ohm	
	t_f	–	–	0.35	(Half Bridge)	

1MBC10D-060, 1MBG10D-060 / IGBT+FWD

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I_{CES}	–	–	1.0	V_{GE}=0V, V_{CE}=600V	mA
Gate-Emitter leakage current	I_{GES}	–	–	20	V_{CE}=0V, V_{GE}=±20V	μA
Gate-Emitter threshold voltage	$V_{GE(th)}$	5.5	–	8.5	V_{CE}=20V, I_C=10mA	V
Collector-Emitter saturation voltage	$V_{CE(sat)}$	–	–	3.0	V_{GE}=15V, I_C=10A	V
Input capacitance	C_{ies}	–	700	–	V_{GE}=0V	pF
Output capacitance	C_{oes}	–	150	–	V_{CE}=10V	
Reverse transfer capacitance	C_{res}	–	20	–	f=1MHz	
Turn-on time	t_{on}	–	–	1.2	V_{CC}=300V, I_C=10A	μs
	t_r	–	–	0.6	V_{GE}=±15V	
Turn-off time	t_{off}	–	–	1.0	R_G=220 ohm	
	t_f	–	–	0.35	(Half Bridge)	
FWD forward on voltage	V_F	–	–	3.0	I_F=10A, V_{GE}=0V	V
Reverse recovery time	t_{rr}	–	–	0.3	I_F=10A, V_{GE}=-10V, di/dt=100A/μs	μs

● Thermal resistance characteristics

1MBC10-060 / IGBT

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	Rth(j-c)	–	–	1.66	IGBT	°C/W

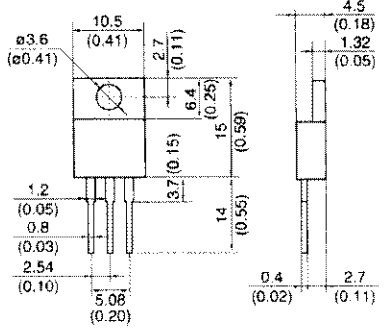
1MBC10D-060, 1MBG10D-060 / IGBT+FWD

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	Rth(j-c)	–	–	1.66	IGBT	°C/W
	Rth(j-c)	–	–	3.57	FWD	°C/W

■ Outline drawings, mm

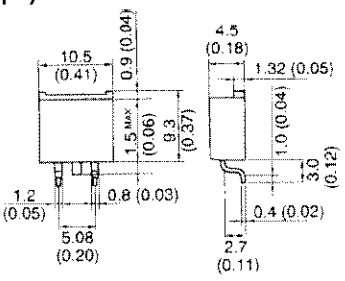
1MBC10-060, 1MBC10D-060

TO-220AB



1MBG10D-060

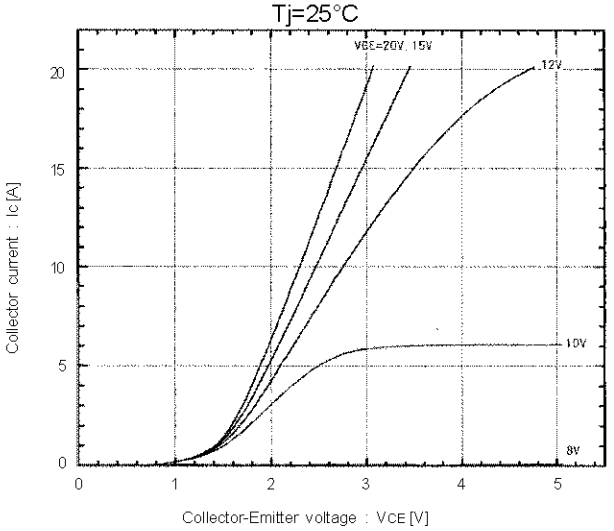
T pack-S (SMD type)



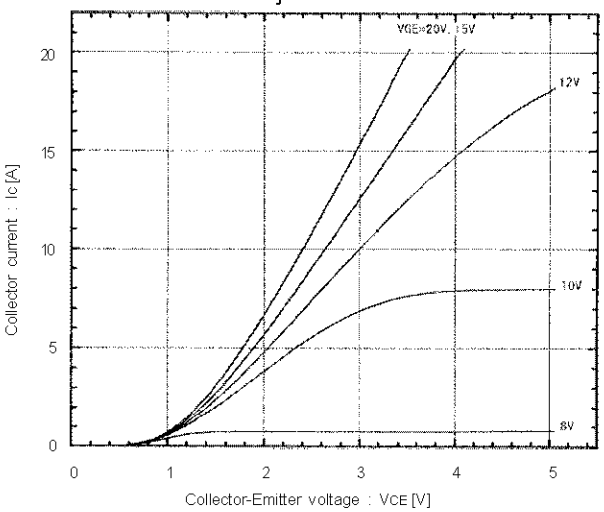
■ Characteristics

1MBC10-060,1MBC10D-060,1MBG10D-060

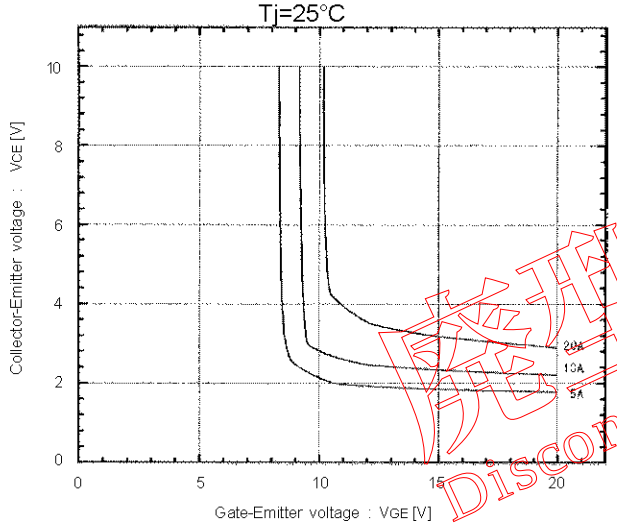
Collector current vs. Collector-Emitter voltage
Tj=25°C



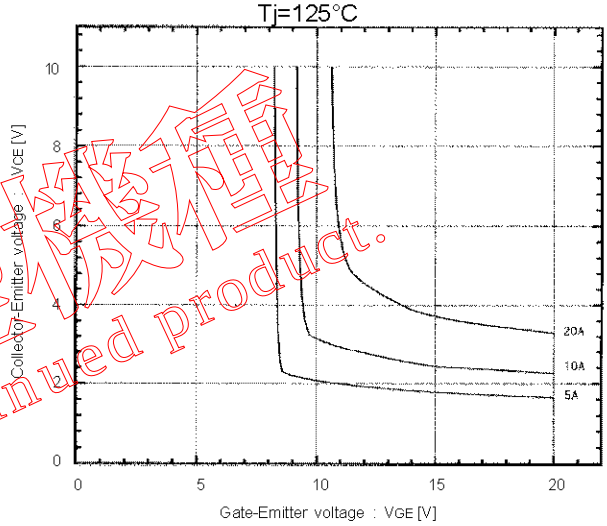
Collector current vs. Collector-Emitter voltage
Tj=125°C



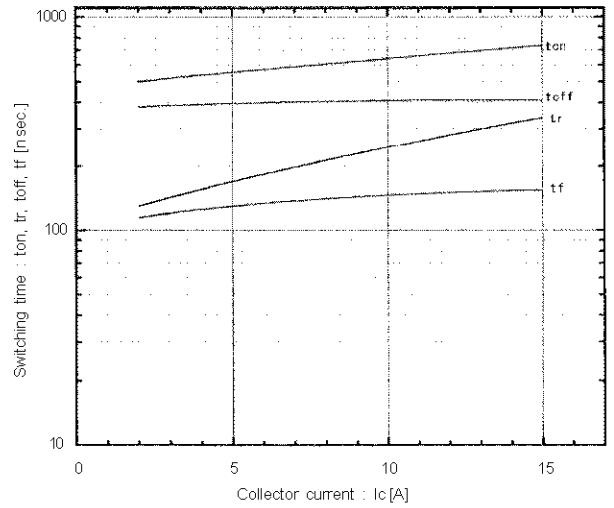
Collector-Emitter vs. Gate-Emitter voltage
Tj=25°C



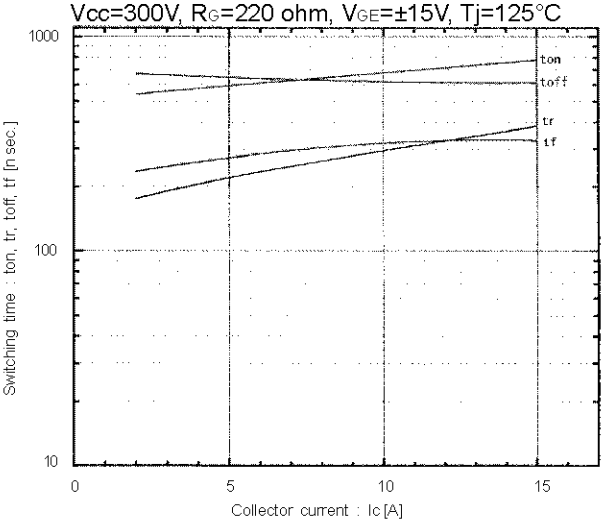
Collector-Emitter vs. Gate-Emitter voltage
Tj=125°C



Switching time vs. Collector current
Vcc=300V, RG=220 ohm, VGE=±15V, Tj=25°C



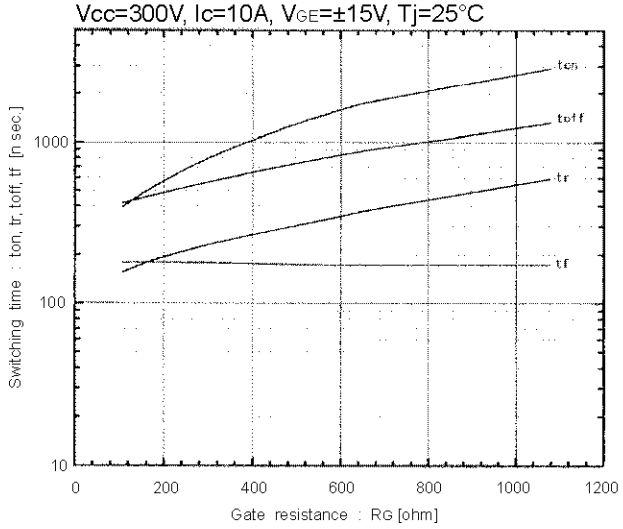
Switching time vs. Collector current
Vcc=300V, RG=220 ohm, VGE=±15V, Tj=125°C



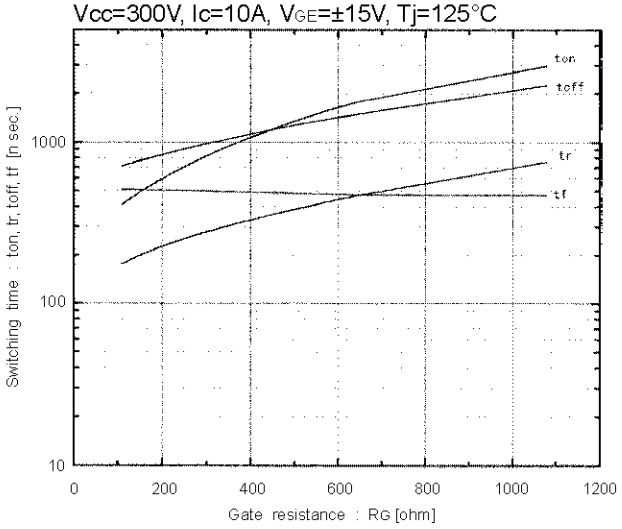
■ Characteristics

1MBC10-060,1MBC10D-060,1MBG10D-060

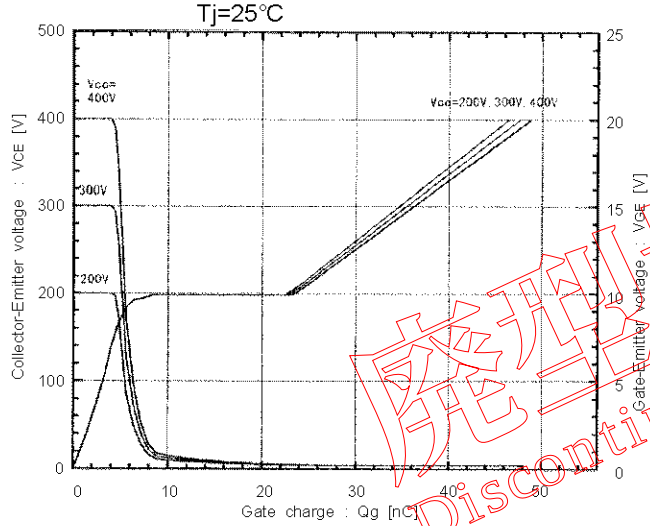
Switching time vs. RG
Vcc=300V, Ic=10A, VGE=±15V, Tj=25°C



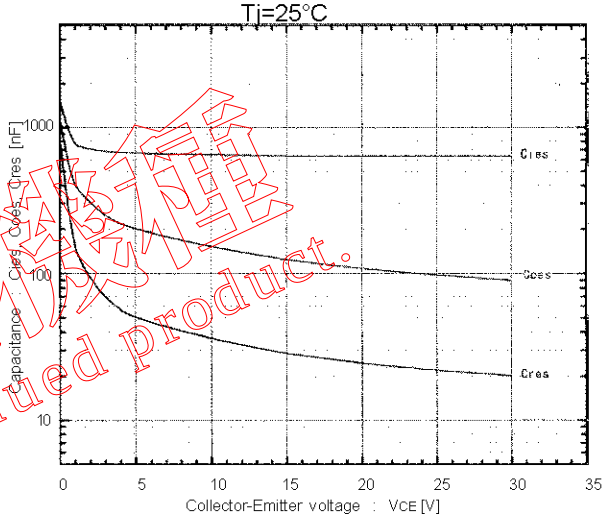
Switching time vs. RG
Vcc=300V, Ic=10A, VGE=±15V, Tj=125°C



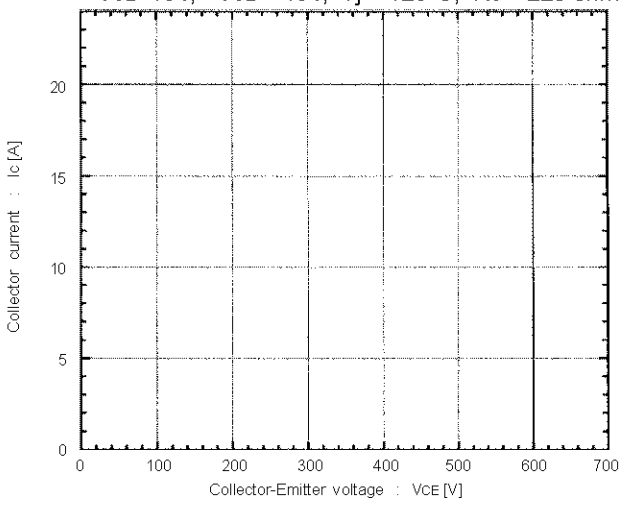
Dynamic input characteristics
Tj=25°C



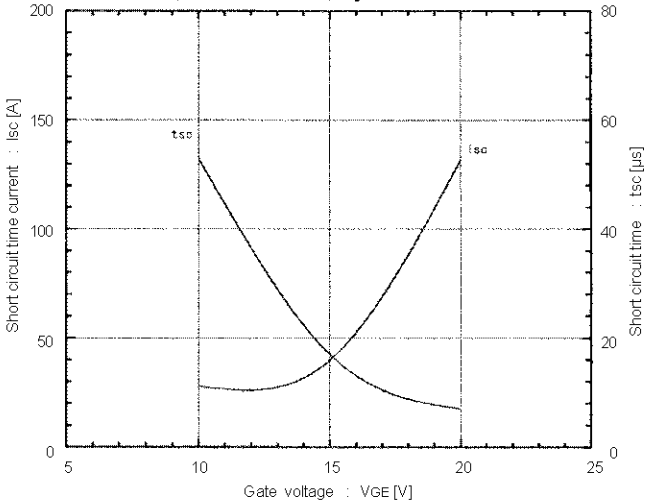
Capacitance vs. Collector-Emitter voltage
Tj=25°C



Reversed biased safe operating area
+VGE=15V, -VGE ≦ 15V, Tj ≦ 125°C, RG ≧ 220 ohm



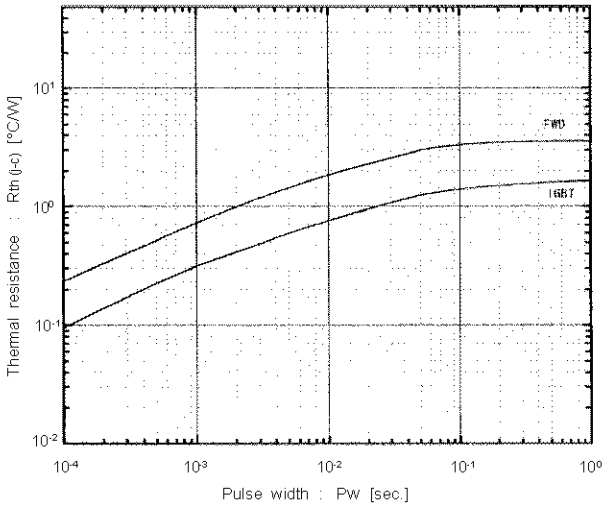
Typical short circuit capability
Vcc=400V, RG=220 ohm, Tj=125°C



■ Characteristics

1MBC10-060,1MBC10D-060,1MBG10D-060

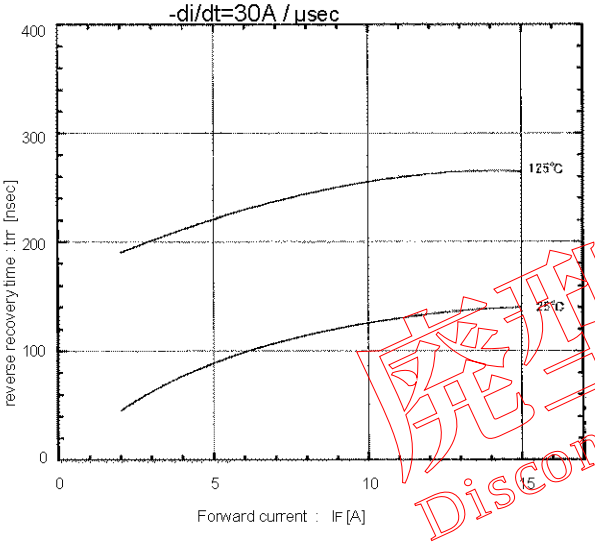
Transient thermal resistance



1MBC10D-060,1MBG10D-060

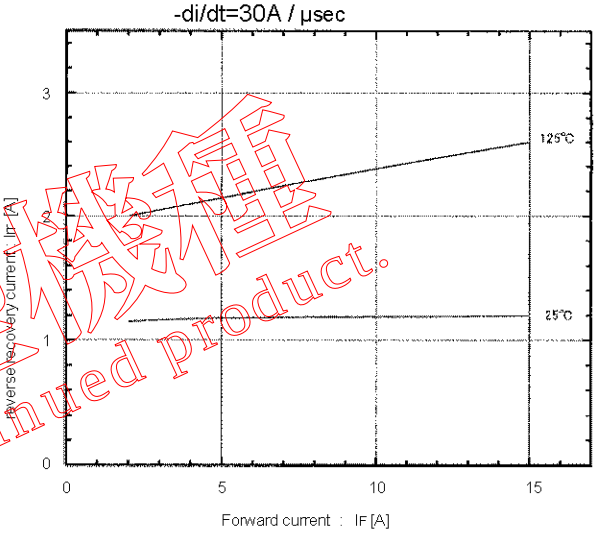
Reverse recovery time vs. Forward current

-di/dt=30A / μsec

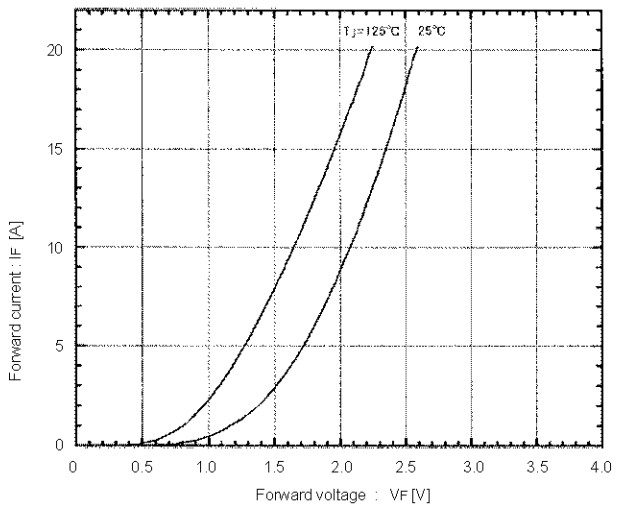


Reverse recovery current vs. Forward current

-di/dt=30A / μsec



Forward current vs. Foeward voltage



Reverse recovery time characteristics vs. -di/dt

IF=10A, Tj=125°C